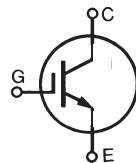


GenX3™ 600V IGBT

IXGB200N60B3

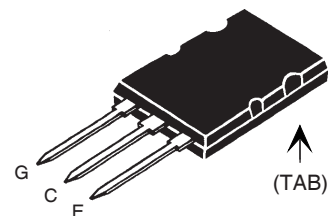
Medium speed low V_{sat} PT IGBTs 5-40 kHz switching



V_{CES} = 600V
I_{C110} = 200A
V_{CE(sat)} ≤ 1.5V
t_{fi(typ)} = 183ns

Symbol	Test Conditions	Maximum Ratings	
V _{CES}	T _J = 25°C to 150°C	600	V
V _{CGR}	T _J = 25°C to 150°C, R _{GE} = 1 MΩ	600	V
V _{GES}	Continuous	±20	V
V _{GEM}	Transient	±30	V
I _{C25}	T _C = 25°C (limited by leads)	75	A
I _{C110}	T _C = 110°C (chip capability)	200	A
I _{CM}	T _C = 25°C, 1ms	600	A
SSOA	V _{GE} = 15V, T _{VJ} = 125°C, R _G = 1Ω	I _{CM} = 300	A
(RBSOA)	Clamped inductive load @ V _{CE} ≤ 600V		
P _C	T _C = 25°C	1250	W
T _J		-55 ... +150	°C
T _{JM}		150	°C
T _{stg}		-55 ... +150	°C
T _L	Maximum lead temperature for soldering	300	°C
T _{SOLD}	Plastic body for 10s	260	°C
F _C	Mounting force	30..120/6.7..27	N/lb.
Weight		10	g

PLUS264™ (IXGB)



G = Gate C = Collector
 E = Emitter TAB = Collector

Features

- NPT IGBT technology
- Low switching losses
- Low tail current
- No latch up
- Short circuit capability
- Positive temperature coefficient for easy paralleling
- MOS input, voltage controlled
- Optional ultra fast diode
- International standard package

Advantages

- Space savings
- High power density power supplies
- Low gate charge results in simple drive requirement

Applications

- High Frequency Inverters
- UPS and Welding
- AC and DC Motor Controls
- Power Supplies and Drivers for Solenoids, Relays and Connectors
- PFC Circuits
- Battery Chargers

Symbol	Test Conditions (T _J = 25°C, unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
BV_{CES}	I _C = 250μA, V _{GE} = 0V	600		V
V_{GE(th)}	I _C = 250μA, V _{CE} = V _{GE}	3.0		V
I_{CES}	V _{CE} = V _{CES} V _{GE} = 0V T _J = 125°C			25 μA 5.0 mA
I_{GES}	V _{CE} = 0V, V _{GE} = ±20V			±100 nA
V_{CE(sat)}	I _C = 100A, V _{GE} = 15V, Note 1 I _C = 200A T _J = 125°C		1.35 1.65 1.75	V V V

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
g_{fs}	$I_C = 60\text{A}, V_{CE} = 10\text{V}$, Note 1	95	160	S
C_{ies} C_{oes} C_{res}	$V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$		26	nF
			1260	pF
			97	pF
$Q_{g(on)}$ Q_{ge} Q_{gc}	$I_C = 100\text{A}, V_{GE} = 15\text{V}, V_{CE} = 0.5 \cdot V_{CES}$		750	nC
			115	nC
			245	nC
$t_{d(on)}$ t_{ri} E_{on} $t_{d(off)}$ t_{fi} E_{off}	Inductive load, $T_J = 25^\circ\text{C}$ $I_C = 100\text{A}, V_{GE} = 15\text{V}$ $V_{CE} = 300\text{V}, R_G = 1\Omega$		44	ns
			83	ns
			1.6	mJ
			310	450 ns
			183	300 ns
			2.9	4.5 mJ
$t_{d(on)}$ t_{ri} E_{on} $t_{d(off)}$ t_{fi} E_{off}	Inductive load, $T_J = 125^\circ\text{C}$ $I_C = 100\text{A}, V_{GE} = 15\text{V}$ $V_{CE} = 300\text{V}, R_G = 1\Omega$		42	ns
			80	ns
			2.4	mJ
			430	ns
			300	ns
			4.2	mJ
R_{thJC} R_{thCS}		0.13	$0.10 \text{ } ^\circ\text{C/W}$ $^\circ\text{C/W}$	

ISOPLUS264™ (IXGB) Outline

Note: Bottom heatsink meets 2500Vrms Isolation to the other

Sym	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.190	.205	4.83	5.21
At	.102	.118	2.59	3.00
A2	.046	.055	1.17	1.40
b	.045	.055	1.14	1.40
b1	.087	.102	2.21	2.59
b2	.111	.126	2.82	3.20
c	.020	.029	0.51	0.74
D	1.020	1.040	25.91	26.42
E	.770	.788	19.56	20.29
e	215 BSC		5.46 BSC	
L	.780	.820	19.81	20.83
L1	.080	.102	2.03	2.59
Q	.210	.235	5.33	5.97
Q1	.480	.513	12.45	13.03
R	.150	.180	3.81	4.57
R1	.100	.130	2.54	3.30
S	.688	.690	16.97	17.53
T	.801	.821	20.34	20.85
U	.085	.080	1.85	2.03

Ref: IXYS CO 0128

Note 1: Pulse test, $t \leq 300\mu\text{s}$; duty cycle, $d \leq 2\%$.

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

4,835,592	4,931,844	5,049,961	5,237,481	6,162,665	6,404,065 B1	6,683,344	6,727,585	7,005,734 B2	7,157,338B2
4,850,072	5,017,508	5,063,307	5,381,025	6,259,123 B1	6,534,343	6,710,405 B2	6,759,692	7,063,975 B2	
4,881,106	5,034,796	5,187,117	5,486,715	6,306,728 B1	6,583,505	6,710,463	6,771,478 B2	7,071,537	

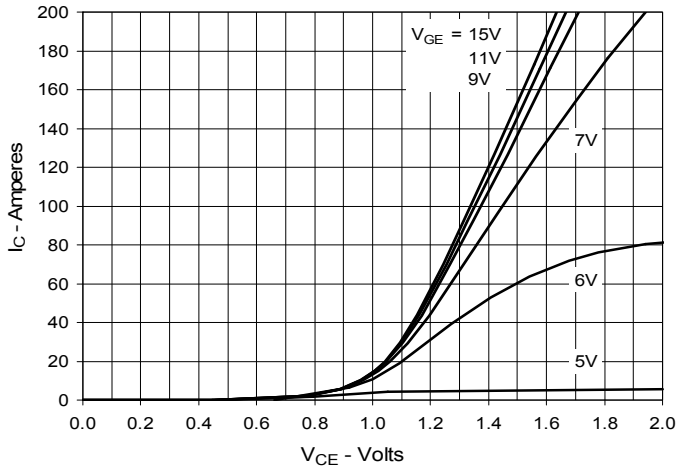
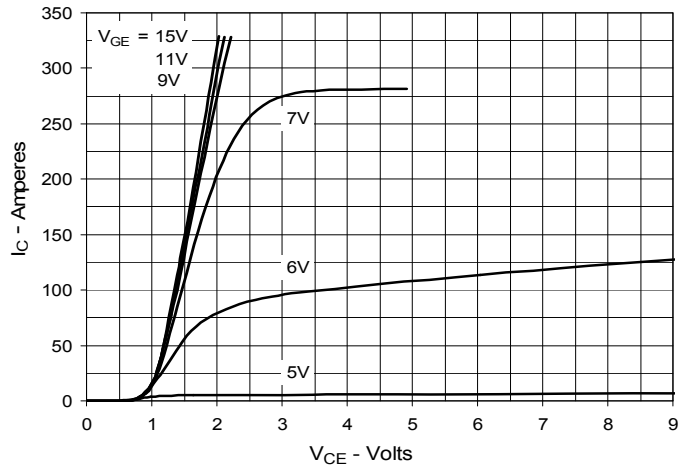
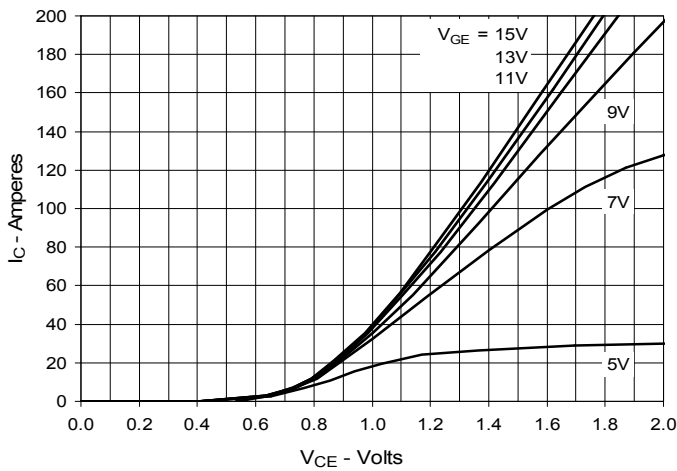
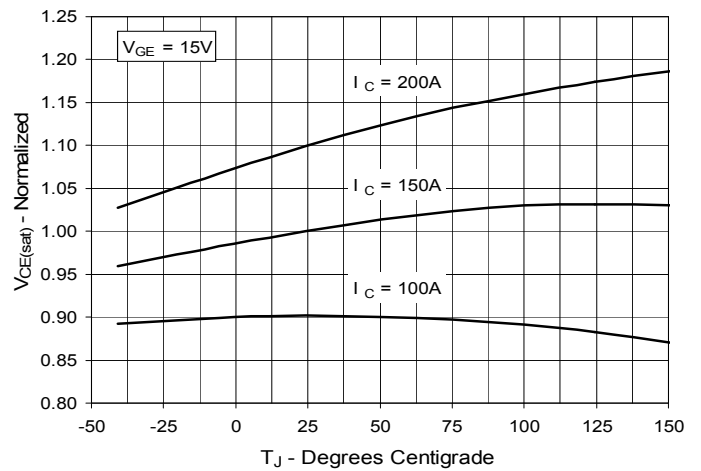
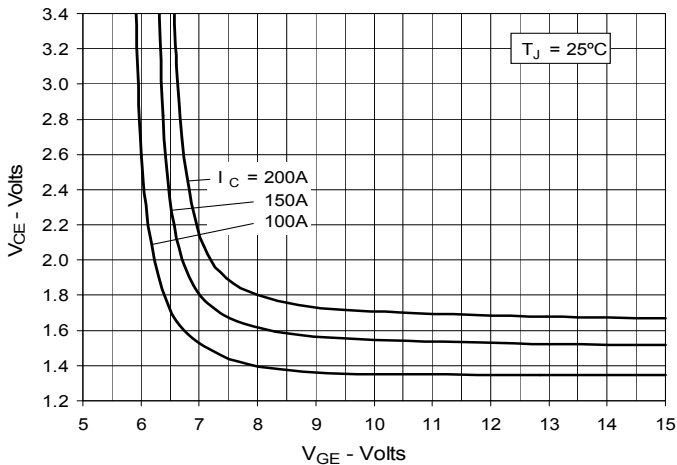
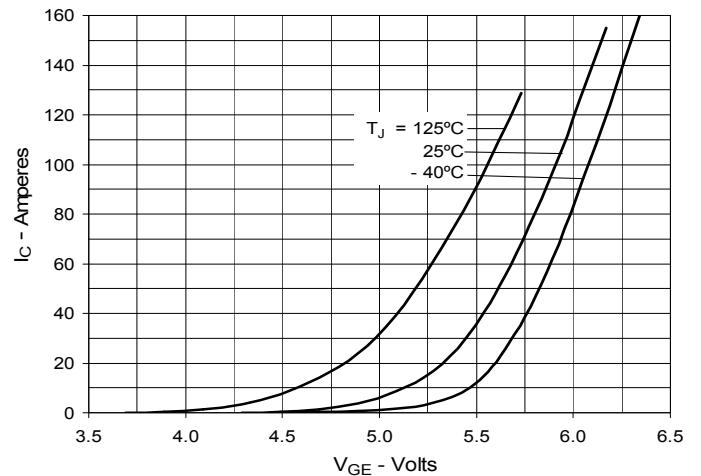
**Fig. 1. Output Characteristics
@ 25°C**

**Fig. 2. Extended Output Characteristics
@ 25°C**

**Fig. 3. Output Characteristics
@ 125°C**

**Fig. 4. Dependence of $V_{CE(sat)}$ on
Junction Temperature**

**Fig. 5. Collector-to-Emitter Voltage
vs. Gate-to-Emitter Voltage**

Fig. 6. Input Admittance


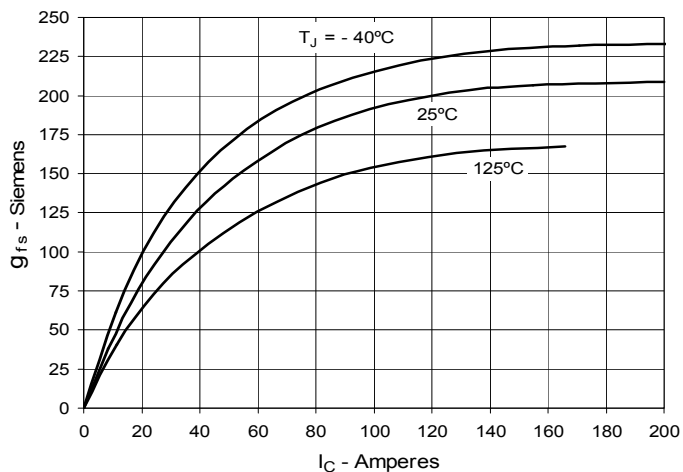
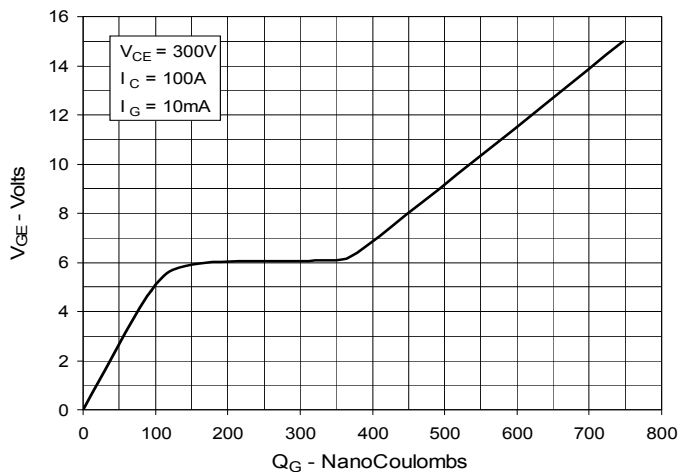
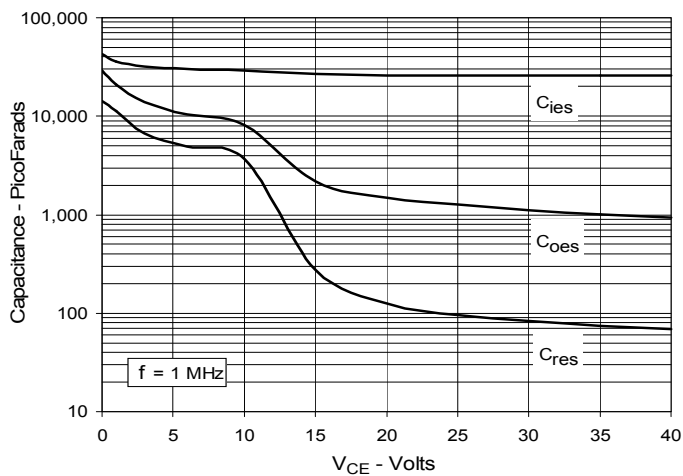
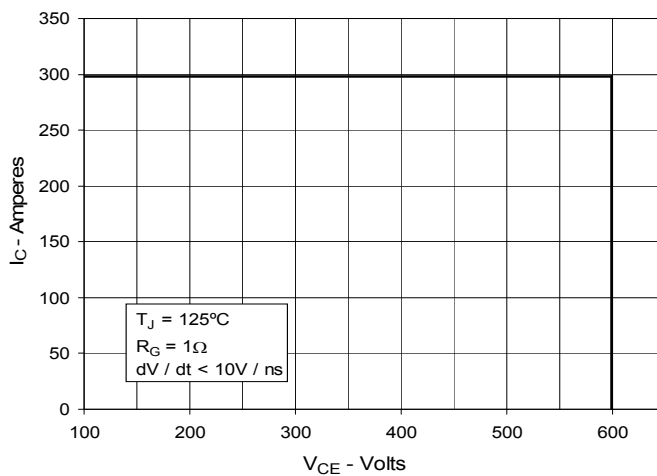
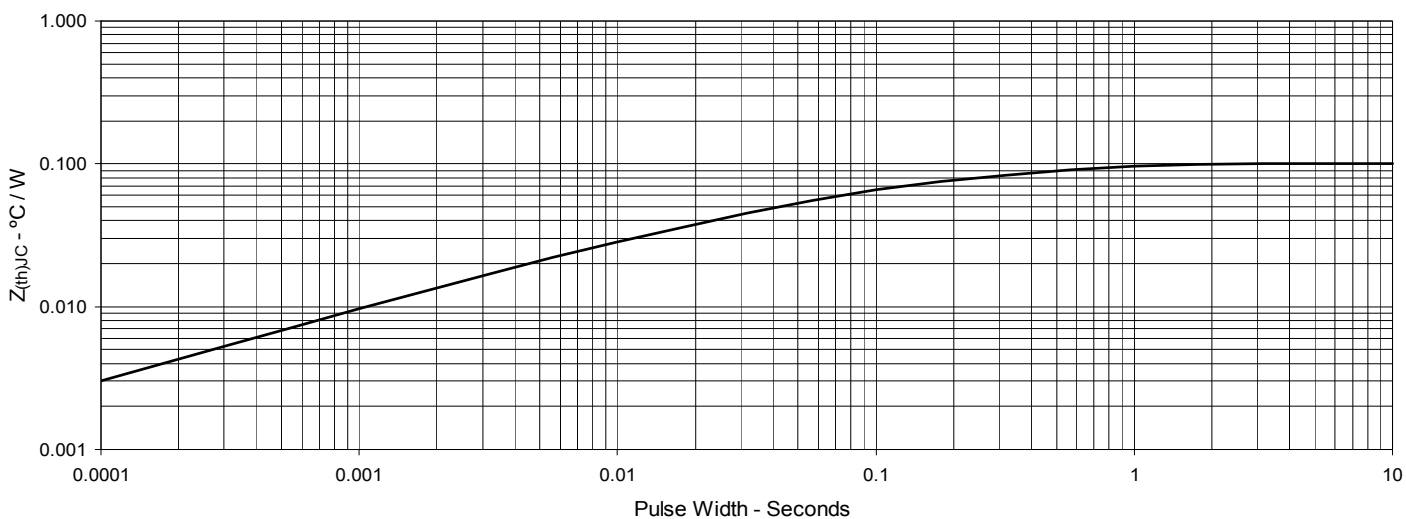
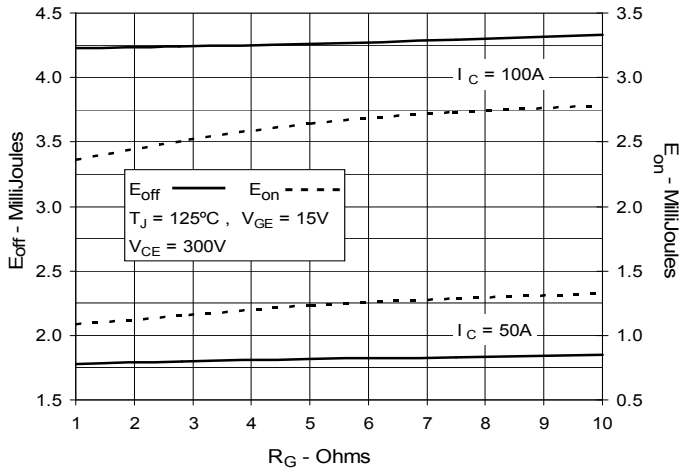
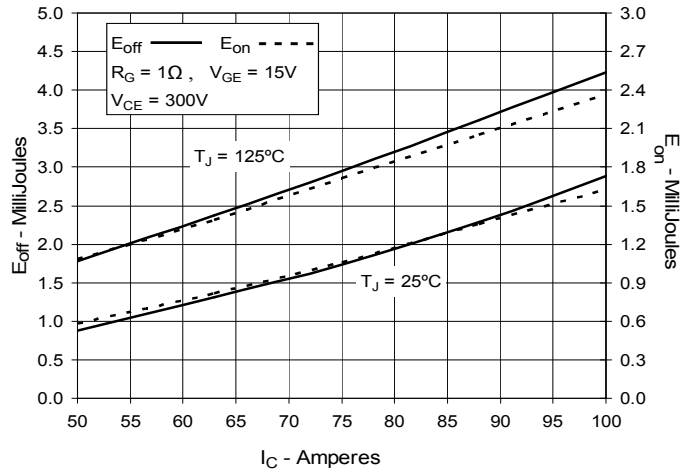
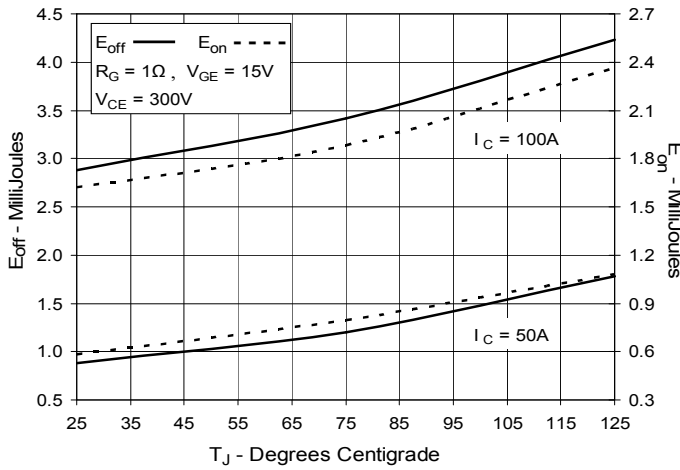
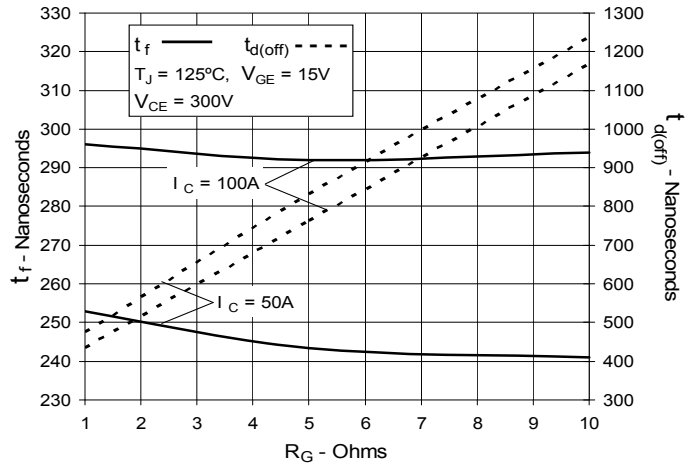
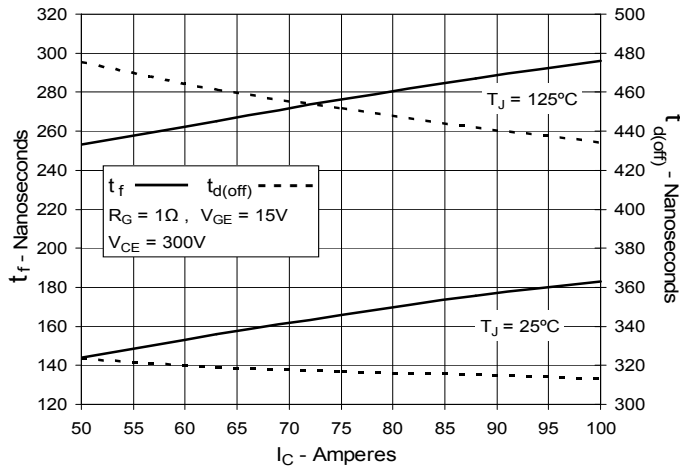
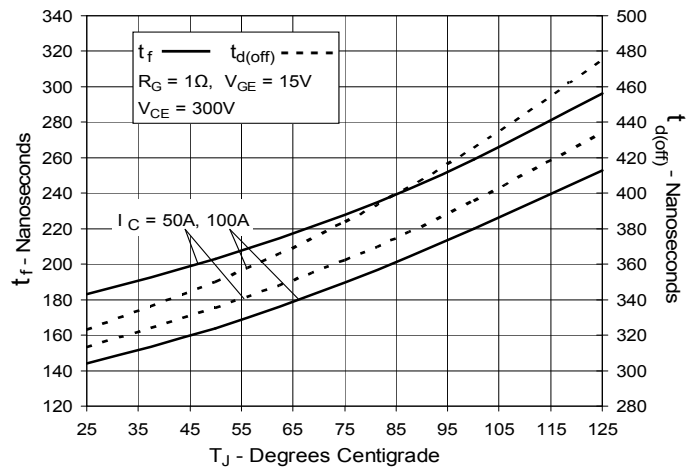
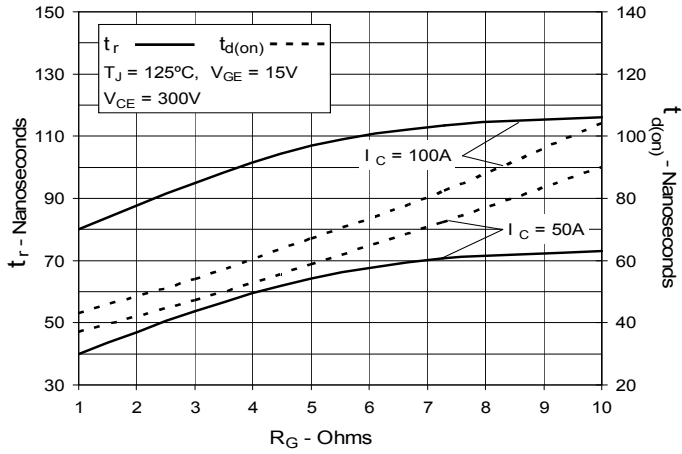
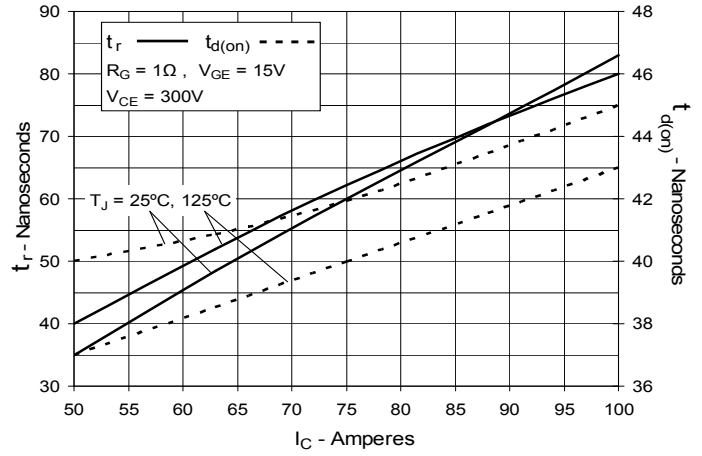
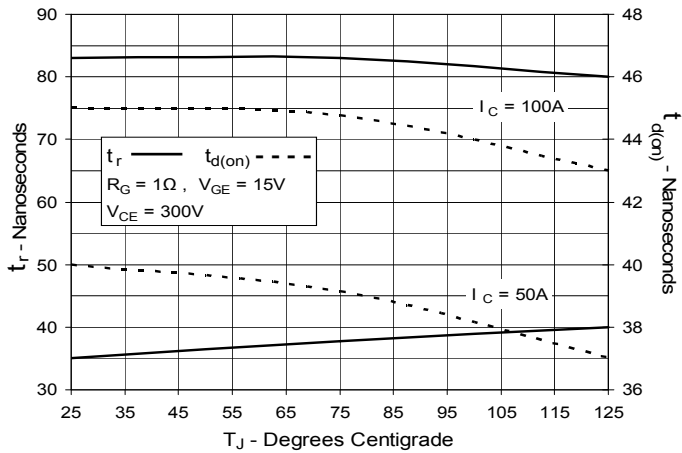
Fig. 7. Transconductance

Fig. 8. Gate Charge

Fig. 9. Capacitance

Fig. 10. Reverse-Bias Safe Operating Area

Fig. 11. Maximum Transient Thermal Impedance


Fig. 12. Inductive Switching Energy Loss vs. Gate Resistance

Fig. 13. Inductive Switching Energy Loss vs. Collector Current

Fig. 14. Inductive Switching Energy Loss vs. Junction Temperature

Fig. 15. Inductive Turn-off Switching Times vs. Gate Resistance

Fig. 16. Inductive Turn-off Switching Times vs. Collector Current

Fig. 17. Inductive Turn-off Switching Times vs. Junction Temperature


**Fig. 18. Inductive Turn-on
Switching Times vs. Gate Resistance**

**Fig. 19. Inductive Turn-on
Switching Times vs. Collector Current**

**Fig. 20. Inductive Turn-on
Switching Times vs. Junction Temperature**




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